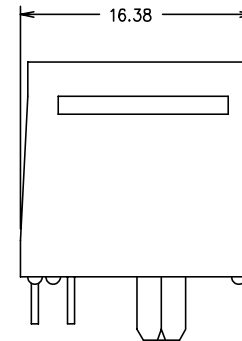
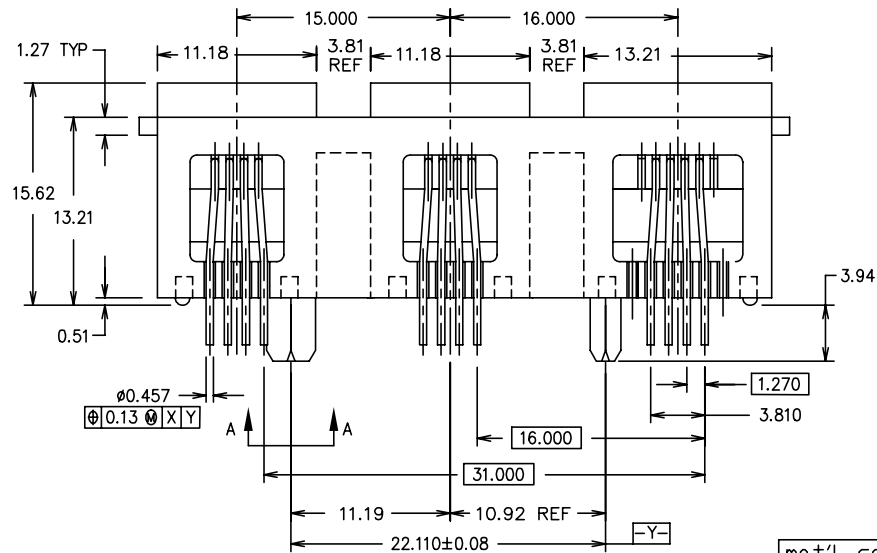
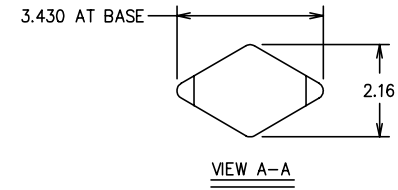
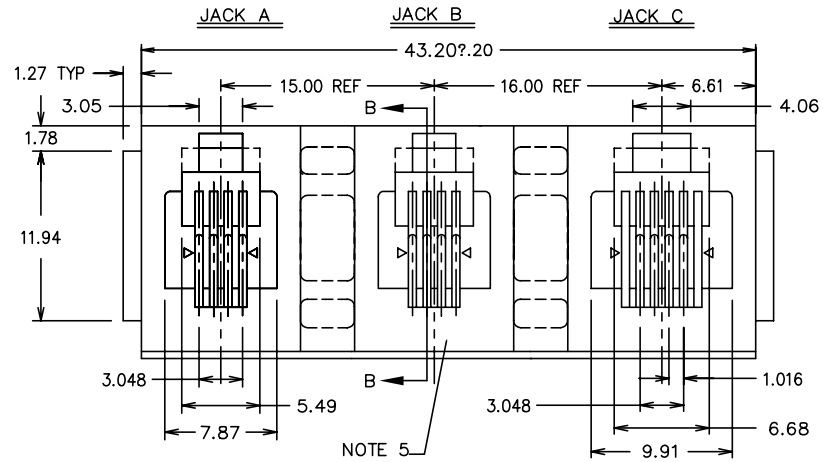


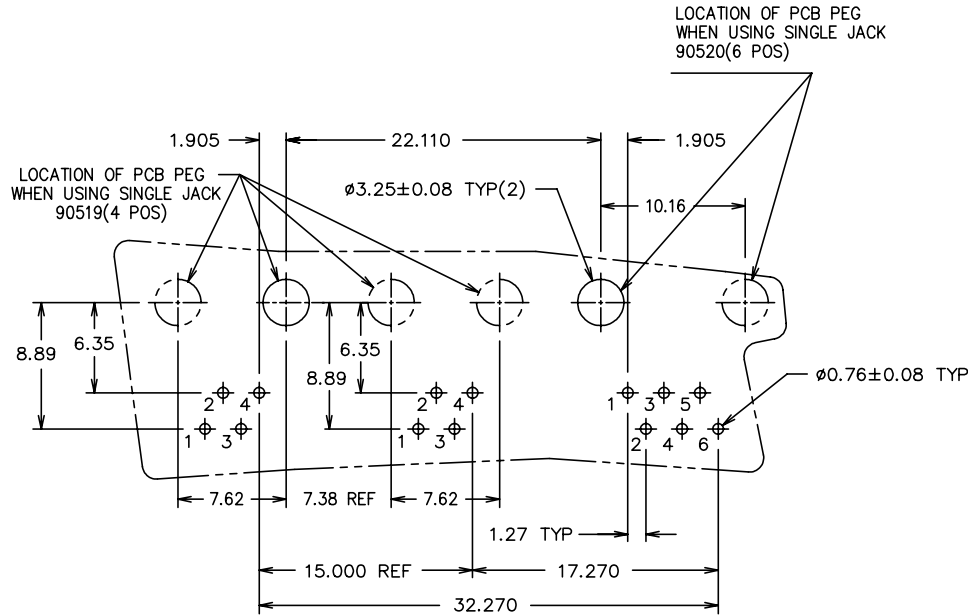
PRODUCT NO.
92266-XXXLF



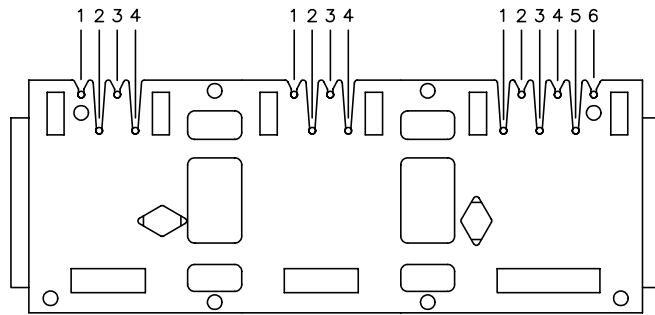
mat'l. code		surface ISO1302 ✓		tolerance ISO1101 ISO406		projection mm		product family MOD JACK		
l t r e c n n o d r		date		tolerances unless otherwise specified		scale 2.0		title		
E	V10414	BKB	1/23/01	angle	0.X±0.3	mm		3-IN-1 GANG JACK		
F	V03-1103	PJ	10/22/03	0°±2'	0.XX±0.15			SOLID PEG (4P+4P+6P)		
G	M05-0066	ERE	04/15/05		0.XXX±0.05			dwg no		
H	N08-0273	SH MMD	12/23/08	chr	K.CHOU	10/5/92	sheet 1 of 2		size	
J	ELX-N-010683	SH MMD	3/14/12	engr	TONY CHEN	10/5/92	92266		A4	
				chr	TONY CHEN	10/5/92	type		Product Customer Drawing	
				appd	JENN TSAO	10/5/92				
sheet index	revision	J	J							
	sheet	1	2							

PRODUCT NO.
92266-XXXLF

PRODUCT NO ⑥	WIRE NUMBER LOADED			DIM D	PACKAGING NOTE 4
	JACK A(4 POS)	JACK B(4 POS)	JACK C(6 POS)		
92266-X01LF 92266-X01HLF	ALL	ALL	2.3.4.5	2.41±.51	
92266-X02LF 92266-X02HLF	ALL	ALL	2.3.4.5	2.41±.51	GPax
92266-X03LF 92266-X03HLF	ALL	ALL	ALL	2.41±.51	
92266-X04LF 92266-X04HLF	ALL	ALL	ALL	2.41±.51	GPax
92266-X05LF 92266-X05HLF	ALL	ALL	2.3.4.5	3.18±.51	



BOARD LAYOUT VIEW FROM TOP (4 POS + 4 POS + 6POS)



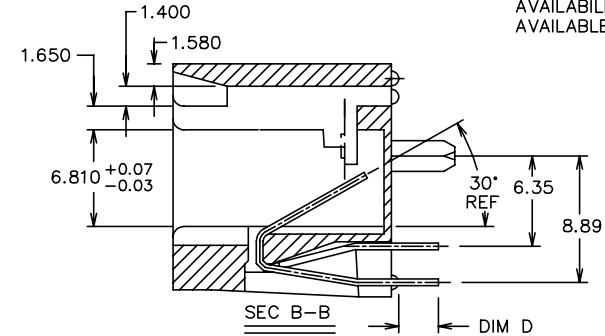
CONTACT SPRING WIRE POS.

LOCATION OF PCB PEG
WHEN USING SINGLE JACK
90520(6 POS)

LOCATION OF PCB PEG
WHEN USING SINGLE JACK
90519(4 POS)

MEETS PIP PROCESS PRODUCT NO.

PLATING CODE X	PLATING ⑨
0	5u" Au + high performance lubricant
3	5u" Au + high performance lubricant
5	1.27uM/50u" GXT



NOTE: PLEASE CHECK FOR
AVAILABILITY, NOT ALL OPTIONS
AVAILABLE.

NOTES:

- MATERIAL:
-PLASTIC HSG: POLYESTER 30 % G. F., UL 94V-0, COLOR: BLACK
-CONTACT SPRING WIRE: PHOSPHOR BRONZE ALLOY 510
IN ACCORDANCE WITH ASTM B-159, 0.460mm/.018in DIA ROUND WIRE, SEE TABLE.
- FOR VISUAL, MECHANICAL, AND FUNCTIONAL REQUIREMENTS, SEE PRODUCT SPECIFICATION: BUS-12-068
- THIS PRODUCT COMPLIES WITH FCC PART 68 DIMENSION, TOLERANCE AND PLATING REQUIREMENT.
- UNLESS OTHERWISE SPECIFIED, PRODUCT IS PACKED IN TUBE PER COMPANY PKG SPEC. BUS-14-164.
- COMPANY LOGO LOCATED IN THIS AREA.
- LF SUFFIX AT THE END OF PART NUMBER IS LEAD FREE.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm MINIMUM THICK CIRCUIT BOARD. SEE APPLICATION NOTES/ PROCEDURES IF THEY ARE AVAILABLE.
- THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008
- PLATING OPTIONS: MAY BE EITHER GOLD OR GXT PLATED AT MANUFACTURER'S OPTION.

mat'l. code	surface ISO1302	tolerance ISO1101 ISO406	projection ISO1101	product family MOD JACK
l trechn nodr	date	tolerances unless otherwise specified	mm	title
E V10414 BKB	1/23/01	0.X±0.3	mm	3-IN-1 GANG JACK
F V03-1103 PJ	10/22/03	0.XX±0.15	scale 2.0	SOLID PEG (4P+4P+6P)
G M05-0066 ERE	04/15/05	0.XXX±0.05		
H N08-0273 SH MMD	12/23/08	dr K.CHOU	10/5/92	dwg no
J ELX-N-010683 SH MMD	3/14/12	engr TONY CHEN	10/5/92	sheet 2 of 2
		chr TONY CHEN	10/5/92	size
		appd JENN TSAO	10/5/92	92266
sheet	revision			type Product Customer Drawing
index	sheet			